

STN	Integrácia softvérového nástroja (FDI®) Časť 6-200: Technologické mapovanie HTML5	STN EN IEC 62769-6-200 18 4012
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Field Device Integration (FDI) - Part 6-200: Technology Mapping - HTML5

Táto norma obsahuje anglickú verziu európskej normy.
This standard includes the English version of the European Standard.

Táto norma bola oznámená vo Vestníku ÚNMS SR č. 07/23

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EUROPEAN STANDARD

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ICS 25.040.40; 35.100.05

English Version

**Field Device Integration (FDI®) - Part 6-200: Technology
Mapping - HTML5
(IEC 62769-6-200:2023)**

Intégration des appareils de terrain (FDI®) - Partie 6-200:
Mapping de technologies - HTML5
(IEC 62769-6-200:2023)

Feldgeräteintegration (FDI®) - Teil 6-200: FDI-
Technologieabbildungen - HTML5
(IEC 62769-6-200:2023)

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EN IEC 62769-6-200:2023 (E)**European foreword**

The text of document 65E/870/CDV, future edition 1 of IEC 62769-6-200, prepared by SC 65E "Devices and integration in enterprise systems" of IEC/TC 65 "Industrial-process measurement, control and automation" was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN IEC 62769-6-200:2023.

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Annex ZA (normative)

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<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
FCG TS10099	-	Field Device Integration (FDI®) – Technology Management	-	-
IEC 62769-1	2021	Field Device Integration (FDI) - Part 1: Overview	EN IEC 62769-1	2021
IEC 62769-2	2021	Field Device Integration (FDI) - Part 2: FDI Client	EN IEC 62769-2	2021
IEC 62769-4	-	Field Device Integration (FDI®) - Part 4: FDI Packages	-	-
IEC 62769-6-100	-	Field Device Integration (FDI®) - Part 6-100: Technology Mapping - .Net	-	-
W3C HTML5.0	-	W3C Recommendation HTML5 - A vocabulary and associated APIs for HTML and XHTML	-	-



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INTERNATIONAL STANDARD

NORME INTERNATIONALE



**Field Device Integration (FDI®) –
Part 6-200: Technology Mapping – HTML5**

**Intégration des appareils de terrain (FDI®) –
Partie 6-200: Mapping de technologies – HTML5**





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IEC 62769-6-200

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INTERNATIONAL STANDARD

NORME INTERNATIONALE



**Field Device Integration (FDI®) –
Part 6-200: Technology Mapping – HTML5**

**Intégration des appareils de terrain (FDI®) –
Partie 6-200: Mapping de technologies – HTML5**

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FIELD DEVICE INTEGRATION (FDI®) –**Part 6-200: Technology Mapping – HTML5**

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Draft	Report on voting
65E/870/CDV	65E/926/RVC

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this International Standard is English.

This document was drafted in accordance with ISO/IEC Directives, Part 2, and developed in accordance with ISO/IEC Directives, Part 1 and ISO/IEC Directives, IEC Supplement, available at www.iec.ch/members_experts/refdocs. The main document types developed by IEC are described in greater detail at www.iec.ch/publications.

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FIELD DEVICE INTEGRATION (FDI®) –

Part 6-200: Technology Mapping – HTML5

1 Scope

This part of IEC 62769 specifies the technology mapping for the concepts described in the Field Device Integration (FDI®¹) standard. The technology mapping focuses on implementation regarding the components FDI® Client and User Interface Plug-in (UIP) for the Runtime HTML5.

2 Normative references

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